

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10541391
<b>Filing Date:</b>	01-Jul-2005
<b>Title of Invention:</b>	Expandable resin beads of styrene-modified straight-chain and low-density polyethylene, process for production thereof, pre-expand beads, and foams
<b>First Named Inventor/Applicant Name:</b>	Hideyasu Matsumura
<b>Filer:</b>	Bruce H. Bernstein/Son T. Nguyen
<b>Attorney Docket Number:</b>	P28122

Filed as Large Entity

### U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				
Extension - 1 month with \$0 paid	1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				120